

EPOXY POTTING EPT-277-2K

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FILLING A COMPLETE ELECTRONIC ASSEMBLY

PRODUCT DESCRIPTION

EPOXY POTTING EPT-277-2K is two components solvent-free epoxy specially designed to fill a complete electronic assembly to improve resistance from shock, vibration, moisture/or water and any other corrosive materials. This product have good electrical insulation (to prevent short circuit), but sufficient heat conductivity (to prevent overheating).

FIELDS OF APPLICATION

- Electronic industry

PRODUCT FEATURES

- Good electrical insulation
- Sufficient heat conductivity
- Solvent free, low odor
- Good flow, easy to apply

PRODUCT SPECIFICATION

Type	: Two components solvent-free epoxy	Component A	Component B
		EPOXY POTTING EPT-277-2K	HARDENER EPT-277 PS
Color	: Black		Clear yellowish liquid
Specific gravity	: 1.90 ± 0.04 gr/ml		0.98 ± 0.02 gr/ml
Solid by volume (mixture)	: 98 ± 1 %		
Flash point	: n.a.		
Material consumption	: Varried, at least 6000 gr/m ²		
Drying time (@ 30°C)	:		
1. Surface dry	: 4 hours		
2. Hard dry	: 16 hours		
3. Full cure	: 7 days		
Packaging	: 1 Kg-set		
Storage stability	: Two year in cool and dry storage (above freezing point) and in original unopened box.		
Mixing ratio by weight	: Comp A : B = 4 : 1 w/w		
Pot life (@30°C)	: 30 minutes		
Application method	: Pour		
Substrate	: Electrical assembly, Printed Circuit Board (PCB)		
Application viscosity	: Ready for Use		
Re-coating interval	: 16 hours		
Application condition	: T = 25-35 °C, RH = maximum 80%		
Provide adequate ventilation during application and drying			

FILM PROPERTIES

Item	Result	Standard Test
Adhesion on Substrate	: 5B	ASTM D3359
Electrical Resistance: - Surface to surface	: > 1 x 10 ⁹ Ohm	ASTM F-150
Impact Resistant	: 50 cm, 1 Kg load	ASTM D-2794
Shore D Hardness	: 80	ASTM D-2240

**all properties tested using panel that has been cured for at least 28 days @ 30°C*

OTHERS

Shelf life	: 24 months.
Storage and handling	: Store at maximum temperature 35 °C. If store under elevated temperature will shorten the shelf life. Avoid from heat and direct sunlight

SUBSTRATE PREPARATION

Make sure that electrical assembly meets the project design requirement, before applying this product. Cover the external port, and make proper mold around the object.

APPLICATION INFORMATION

1. Mix **EPOXY POTTING EPT-277-2K** with **HARDENER EPTH-277 PS** at mixing ratio A:B = 4:1 (w/w), using electrical mixer or appropriate method.
2. Pour the mixture on the substrate.
3. Leave it dry for at least 24 hours.
4. Good ventilation and air circulation in working area is suggested.

SIMPLIFIED RECOMMENDED COATING SYSTEM

No.	APPLICATION STEP and PRODUCT CODE	MIXING	RECOMMENDED COATING AMOUNT	CURING @ 30 °C.
Substrate: Electrical assembly, PCB				
	Create a proper mold around the object			
1	Epoxy Potting			
	EPOXY POTTING EPT-277-2K	4	6000 gr/m ² for 3000 mic DFT	16 hours
	HARDENER EPTH-277 PS	1		

SAFETY PRECAUTION

Avoid contact with the skin and eyes. Wear suitable protective clothing such as goggles, masks, and gloves. For more information, please refer to our safety data sheet.

FIRST AID:

- Eye contact : Rinse immediately with plenty of water for at least 15 minutes; seek medical advice.
- Skin contact : Wash with soap and water. If irritation occurs, seek medical advice.
- Ingestion : Provide symptomatic treatment and seek medical advice.
- Inhalation : Remove person to fresh air. Keep patient rested and give artificial respiration.

DISCLAIMER

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